# **PNZ109F** (PN109F)

### Silicon planar type

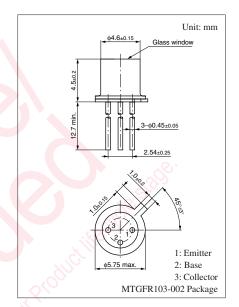
#### For optical control systems

#### ■ Features

- Flat window design which is suited to optical systems
- Built-in filter to cutoff visible light for reducing ambient light noise
- Peak sensitivity wavelength matched with infrared light emitting devices: λp = 900 nm (typ.)
- Fast response:  $t_r = 8 \mu s$  (typ.)
- Long lifetime, high reliability

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

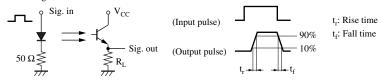
Parameter	Symbol	Rating	Unit	
Collector-emitter voltage (Base open)	$V_{CEO}$	20	V	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	30	V	
Emitter-collector voltage (Base open)	V <sub>ECO</sub>	3	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V	
Collector current	I <sub>C</sub>	30	mA	
Collector power dissipation	P <sub>C</sub>	150	mW	
Operating ambient temperature	$T_{opr}$	-25 to +85	°C	
Storage temperature	$T_{stg}$	-30 to +100	S °C	



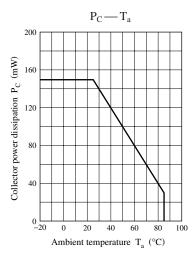
#### ■ Electrical-Optical Characteristics $T_a = 25$ °C $\pm 3$ °C

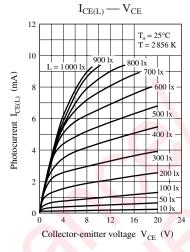
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Photocurrent *1	I <sub>CE(L)</sub>	$V_{CE} = 10 \text{ V}, L = 100 \text{ lx}$	0.3			mA
Dark current	$I_{CEO}$	$V_{CE} = 10 \text{ V}$	0.7	0.05	2.00	μΑ
Peak emission wavelength	$\lambda_{\mathrm{p}}$	$V_{CE} = 10 \text{ V}$	)	900		nm
Half-power angle	θ	The angle from which photocurrent		40		0
		becomes 50%				
Rise time *2	t <sub>r</sub>	$V_{CC} = 10 \text{ V}, I_{CE(L)} = 1 \text{ mA}, R_L = 100 \Omega$		8		μs
Fall time *2	t <sub>f</sub>	28 2 1/4°		9		μs
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_{CE(L)} = 1 \text{ mA}, L = 1000 \text{ lx}$		0.3	0.6	V

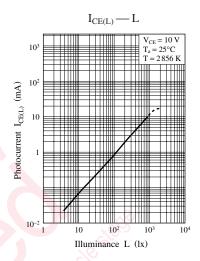
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
  - 2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.
  - 3. This device is designed be disregarded radiation.
  - 4. \*1: Source: Tungsten (color temperature 2856 K)
    - \*2: Switching time measurement circuit

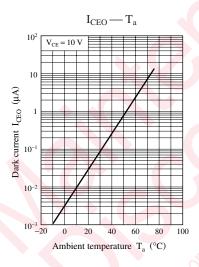


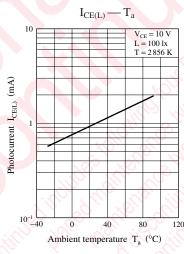
Note) The part number in the parenthesis shows conventional part number.

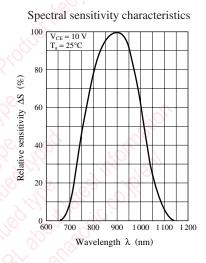


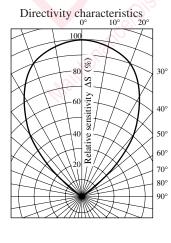




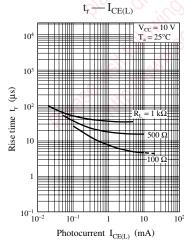


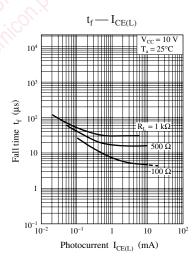






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